Overview

HP EliteBook 640 14 inch G10 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam LED (Optional)
- 3. Camera Shutter (Only available with webcam)
- 4. 5MP IR, HD TNR, or HD TNR IR Camera (Optional)
- 5 IR Camera LED (Optional)
- 6. NFC Sensor

- 7. Clickpad
- 8. Smartcard Reader (Optional)
- 9. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 10. Ethernet Port (RJ-45)
- 11. Nano Security Lock Slot (Lock sold separately)

Overview



Right

- 1. Power Button Key
- 2. Speakers
- 3. Power Connector
- **4.** ThunderboltTM 4 with USB4TM Type-C[®] 40 Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4)¹
- 5. SuperSpeed USB Type-C® 10Gbps signaling rate (USB 10. Power Delivery, DisplayPortTM 1.4)
- 1. SuperSpeed USB 20Gbps is not available with ThunderboltTM 4.

- **6.** SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 7. HDMI 2.1 Port (Cable not included)
- 8. Audio Combo Jack
 - External SIM Card Slot (Optional)
 - **Touch Fingerprint Sensor (Select Models)**

Overview

At a Glance

- Choice of 13th generation Intel® Core™ i7, i5 and i3 processors
- Preinstalled with Windows 11 versions or FreeDOS
- Optional NVIDIA® GeForce® RTX2050 discrete graphics with 4 GB DDR6 dedicated video memory
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 64 GB
- Choice of 35.56 cm (14") diagonal HD, Ultra Wide Viewing Angle FHD, Touch or Non-Touch screen, and Privacy Panel option.
- Features quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of solid state drives up to 2 TB
- Multi-layered security with HP SureStart Gen7, HP Privacy Camera, HP Sure View, HP Wolf Security (Includes HP Sure Sense and HP Sure Click), HP Secure Erase, Sure Run Gen5, Sure Recover Gen5, Touch Fingerprint reader, and Tamper Lock
- Supports wireless options for connectivity on the go including gigabit-speed Wi-Fi® 6e and CAT16 4G/LTE WWAN
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support HP docking options
- Passed MIL-STD 810H tests1
- Battery Life up to 14 hours
- Optimize your video calls with a 5MP+IR camera, HD+IR/HD camera and temporal noise reduction that adjusts to the lighting in your environment.
- 180° synchronized hinge allows the EliteBook to lay completely flat, without lifting the keyboard, and includes everyone with visibility from multiple angles.
- Can be wiped up to 1000 times with common household cleaning wipes²
- Synchronized hinge allows the EliteBook to ProBook to open to 177? +/- 3? without lifting the keyboard and offers visibility from multiple angles.

1. MIL-STD 810GH is not intended to demonstrate fitness of U.S. Department of Defense contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

2. See wipe manufacturer's instructions for disinfecting and the HP cleaning guide for HP tested wipe solutions at http://h20195.www.2.hp.com/v2/GetDocument.aspx?docname=4AA7-7610ENW

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Technical Specifications

PRODUCT NAME

HP EliteBook 640 14 inch G10 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 11 Pro ¹

Windows 11 Pro Education ¹

Windows 11 Home - HP recommends Windows 11 Pro for Business 1

Windows 11 Home Single Language - HP recommends Windows 11 Pro for Business 1

Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing

Agreement 1

Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade)^{1,2}

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchase hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated are enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions verquire you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor 3,4,5,6,7	Cores	Number of	Number of	Threads L3		∣ Inreads ∣	Threads	Inreads		Turbo Jency	Ba Frequ	se iency	Intel SIPP/vPro® Enterprise	Intel vPro® Essentials
2,1,2,0,1		P-cores	E-cores		Cache	P-	E-	P-	E-					
						cores	cores	cores	cores					
Intel® Core TM	14	6	8	20	20 24 MB	5.2	3.9	1.9	1.4	x				
i7-1370P	14	0	0	20		GHz	GHz	GHz	GHz					
Intel® Core TM	el® Core TM		5.2	3.9	1.8	1.3								
i7-1365U	10	2	8	12	12 12 MB	GHz	GHz	GHz	GHz	X				
Intel® Core TM		_	_		5.0	3.7	1.7	1.2						
i7-1355U	10	2	8	12	12 12 MB	GHz	GHz	GHz	GHz					
Intel® Core TM	4.5	_	_			4.7	3.5	1.9	1.4	.,				
i5-1350P	12	4	8	16	12 MB	GHz	GHz	GHz	GHz	X				
Intel® Core TM		_	_			4.7	3.5	1.6	1.2					
i5-1345U	10	2	8	12	12 12 MB	GHz	GHz	GHz	GHz	X				
Intel® Core TM		_	_			4.6	3.4	1.3	0.9					
i5-1335U	10	2	8	12	. 12 MB	GHz	GHz	GHz	GHz		Χ			
Intel® Core TM	ГМ		4.5	3.3	1.2	0.9								
i3-1315U	6	2	4	8 10 MB	10 MB	GHz	GHz	GHz	GHz					

^{3.} Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and vour hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher

Technical Specifications

performance.

- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on proceed configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com
- 7. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wirec LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® X? Graphics (Core i5 and Core i7) 8 Intel® UHD Graphics (Core i3)

Discrete

NVIDIA® GeForce® RTX2050 (4 GB DDR6 dedicated)

Supports

Supports CUDA, Optimus, PhysX, GPU Boost 2.0

8. Intel® Iris® X? Graphics capabilities require system to be configured with Intel® CoreTM i5 or i7 processors and dual channel memory. Intel® Iris® X? Graphics with Intel® CoreTM i5 or 7 processors and single channel memory will only function as UHD graphics.

DISPLAY



Technical Specifications

Non-Touch

35.6 cm (14") diagonal, FHD UWVA Low Blue Light IPS anti-glare, 1000 nits, sRGB 100% for 5MP + IR camera and HP Sure View Ger integrated privacy screen with HP Eye Ease (1920 x 1080) 9,10,11,12,13

35.6 cm (14") diagonal, FHD UWVA eDP Low Blue Light IPS anti-glare, 400 nits, 100% for 5MP + IR camera (1920 x 1080) with HP Eve Ease 9,10,11

35.6 cm (14") diagonal, FHD UWVA eDP 1.3+PSR Low Blue Light IPS anti-glare, low power, 400 nits, sRGB 100% for HD + IR camera and WWAN with HP Eye Ease (1920 x 1080) 9,10,11

35.6 cm (14") diagonal, FHD UWVA Low Blue Light IPS anti-glare, 400 nits, 100% eDP for HD Webcam (1920 \times 1080) with HP Eye Ease 9,10,11

35.6 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits, 45% NTSC for HD + IR camera and WWAN $(1920 \times 1080)^{9,10,11}$

35.6 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits,45% NTSC for HD camera and WWAN (1920x1080)

35.6 cm (14") diagonal FHD UWVA eDP anti-glare narrow bezel bent, 250 nits,45% NTSC for HD camera (1920 x 1080) 9,10,11

35.6 cm (14") diagonal FHD UWVA eDP 1.2 w/o PSR anti-glare narrow bezel bent, 250 nits,45% NTSC (1920 x 1080) 9,10,11

35.6 cm (14") diagonal, FHD , IPS anti-glare, micro-edge, 250 nits, 45% NTSC, no mic Narrow Bezel bent for WWAN (1920 x 1080)

35.6 cm (14") diagonal, FHD UWVA eDP1.4 w/o PSR, anti-glare, micro-edge, 250 nits, 45% NTSC, no mic Narrow Bezel bent (1920 1080) 9,10,11

35.6 cm (14") diagonal, HD SVA eDP 1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC for HD Webcam Narrow Bezel bent (1366 x 768)

35.6 cm (14") diagonal, HD SVA eDP 1.2 w/o PSR, Anti-Glare, 250 nits, 45% NTSC Narrow Bezel bent (1366x768) 9,10,11

Touch

35.6 cm (14") diagonal FHD Anti-Glare UWVA eDP narrow bezel bent touch-on-panel screen, 250 nits, 45% NTSC for HD camera (1920 x 1080) ^{9,10,11,13}

Display Size (Diagonal)

14" diagonal 35.6 cm (14") diagonal

- 9. HD content required to view HD images.
- 10. Sold separately or as an optional feature.
- 11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 12. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.
- 13. Actual brightness will be lower with touchscreen or Sure View.

DOCKING (Sold Separately)

Docking station model #1HP Thunderbolt 120W G4 DockDocking station model #2HP Thunderbolt 280W G4 Dock

Docking station model #3 HP USB-C Dock G5

Docking station model #4 Docking station model #5HP USB-C/A Universal Dock G2

HP USB-C G5 Essential Dock

For additional aftermarket options and docking specs please see page 41.

STORAGE AND DRIVES

Technical Specifications

Primary Storage

2 TB PCIe® NVMeTM TLC 2280 Solid State Drive ¹⁴
1 TB PCIe® NVMeTM TLC 2280 Self Encrypted OPAL2 Solid State Drive ¹⁴
1 TB PCIe®? Gen4x4 NVMeTM? M.2 SSD TLC ^{14,52}
512 GB PCIe® NVMeTM TLC 2280 Self Encrypted OPAL2 Solid State Drive ¹⁴
512 GB PCIe® NVMeTM TLC Solid State Drive ¹⁴
512 GB PCIe® NVMeTM Value M.2 SSD ¹⁴
256 GB PCIe® NVMeTM Value 2280 Self Encrypted OPAL2 Solid State Drive ¹⁴
256 GB PCIe® NVMeTM Value M.2 SSD¹⁴

Secondary Storage

256 GB PCIe® NVMeTM Value 2230 2nd Solid State Drive 15

- 14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 a 11) is reserved for system recovery software.
- 15. Secondary SSD slot (M.2 2230 form factor; Optional) is used for data storage only, not used for OS deployment, and is only available with non-WWAN base Unit AND Primary M.2 storage.
- 52. Available only to HK (Hong Kong), TW (Taiwan) and CN (China).

MEMORY

Maximum Memory

64 GB DDR4-3200 SDRAM 16

Memory

64 GB DDR4-3200 SDRAM (2x32GB) ¹⁶ 32 GB DDR4-3200 SDRAM (2x16GB) ¹⁶ 32 GB DDR4-3200 SDRAM (1x32GB) ¹⁶ 16 GB DDR4-3200 SDRAM (2x8GB) ¹⁶ 16 GB DDR4-3200 SDRAM (1x16GB) ¹⁶ 8 GB DDR4-3200 SDRAM (1x8GB) ¹⁶ 8 GB DDR4-3200 SDRAM (2x4GB) ¹⁶

Memory Slots

2 SODIMM Slot is customer accessible / upgradeable DDR4 PC4 SODIMMS (Raptor Lake runs at 3200) Supports Dual Channel Memory

16. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to enscompatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Technical Specifications

WLAN

Intel® AX211 Wi-Fi 6E +Bluetooth® 5.3 M.2 160MHz CNVi World-wide WLAN non-vPro® Wireless Card ¹⁷ Intel® AX211 Wi-Fi 6E +Bluetooth® 5.3 M.2 160MHz CNVi World-wide WLAN vPro® Wireless Card ¹⁷

WWAN

Intel® XMMTM 7560 R+ LTE-Advanced Pro ¹⁸

NFC

NFC Mirage module (NXP NPC300 I2C 10mmx17mm)

Miracast

Native Miracast Support 19

Ethernet

Intel® I219-LM 1 Gigabit Network Connection LOM (vPro) ²⁰ Intel® I219V 1 Gigabit Network Connection LOM (non-vPro) ²⁰

17. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

- 18. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Chewith service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, netwo conditions, and other factors. 4G LTE not available on all products, in all regions.
- 19. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 20. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and d not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power

2W/4ohm Per speaker

Webcam

720p HD camera with Temporal Noise Reduction ^{9,10}
720p HD camera+IR Camera with Temporal Noise Reduction ^{9,10}
5MP camera+IR with Temporal Noise Reduction ^{9,10}
5 MP + IR camera for face authentication with Windows Hello

9. HD content required to view HD images.

10. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Technical Specifications

Keyboard

HP Premium Keyboard, spill resistant with optional backlit function 21

Pointing Device

Clickpad with multi-touch gesture support

Function Keys

F1 - Display Switching

F2 - Blank or SureView On/Off

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Wireless

F12 - Programmable key

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

21. Backlit keyboard is an optional feature.

SOFTWARE AND SECURITY

Preinstalled Software

Software

HP Quick Drop ²²

HP PC Hardware Diagnostics Windows

mvHP with Video Controls

HP Smart Support 23

HP Services Scan 24

HP Connection Optimizer

HP Hotkey Support

HP Support Assistant 25

HP Notifications

HP Privacy Settings

HP Power Manager

Buy Microsoft Office (Sold separately)

Manageability Features

HP Connect ²⁶

HP Image Assistant Gen5 (download)

HP Manageability Integration Kit (download) ²⁷

HP Client Management Script Library (download)

HP Patch Assistant (download) 28

HP Driver Packs (download)

HP Client Catalog (download)

HP Cloud Recovery

Security Management

HP Wolf Security for Business ²⁹ includes:

HP Sure Click 30

HP Sure Sense 31

HP Sure Run 32

Technical Specifications

HP Sure Recover ³³ HP Sure Start ³⁴ HP Tamper Lock HP Sure Admin ³⁵

BIOS

HP BIOSphere Gen6 ³⁶
HP Secure Erase ³⁷
Absolute Persistence Module ³⁸
BIOS Update via Network
HP Wake on WLAN
Secured-Core PC Enable ³⁹
TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)
HP Fingerprint Sensor ⁴⁰

Security

TPM

Model: Nuvoton NPCT760HABYX

Version: 7.2.3.1 Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Support

Yes

FirstNet Certified

Yes

The BIOS on this notebook implements ISO/IEC 19678:2015 guidelines (formerly NIST 800-147).

UEFI version: 2.7

Class: 3

22. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Andro device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

23. HP Smart Support requires HP TechPulse to be installed. For more information about how to enable or to download HP Smart Support, please visit http://www.hp.com/smart-support.

24. HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications and is not sold as a standalone service. HP TechPulse follows stringent GDPR privacy regulations and is ISO27001, ISO27701, ISO27017 and SOC2 Type2 certified for Information Security. Internet access with connection to TechPulse portal is required. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements. Not applicable in China. 25. HP Support Assistant requires Windows and Internet access.

26. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

27. HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.htm 28. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

29. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Prc Elite, RPOS and Workstation products. See product details for included security features..

30. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

31. HP Sure Sense is available on select HP PCs with Windows 10 Pro. Windows 10 Enterprise. Windows 11 Pro. or Windows 11

Technical Specifications

Enterprise OS

32. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

33. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

34. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

35. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store

36. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

37. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® OptaneTM.

38. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, ch with Absolute for availability outside the U.S. Certain conditions apply. For full details visit:

https://www.absolute.com/about/legal/agreements/absolute/

39. Secured-Core PC Enable requires an Intel® vPro®, AMD RyzenTM Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.

40. HP Fingerprint sensor is an optional feature that must be configured at purchase.

POWER

Power Supply

AC Adapter 65 Watt nPFC Standard USB Type C® Straight 1.8m ⁴¹ AC Adapter 65 Watt Smart nPFC EM Barrel 4.5mm New EM⁴¹ AC Adapter 65 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m⁴¹

Battery

HP Long Life 3-cell, 51.3 Wh Polymer ^{42,43} Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m 41

Battery Life

Up to 14 hours with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel U15, Display set to 200 nits display a 400 nit display), 2*4G memory, 256 GB SSD) 44

Up to 13 hours and 30 minutes with 51whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, Intel P28, Display set to 2 nits display (on a 400 nit display), 2*4G memory, 256 GB SSD) 44

Battery Weight

HP Long Life 3-cell - 51.3 Wh Polymer - .45 lb HP Long Life 3-cell - 51.3 Wh Polymer - 203.56 g

- 41. Availability may vary by country.
- 42. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 43. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors. 44. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, feature use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Technical Specifications

Product Weight

Starting at 3.13 lb 45 Starting at 1.41 kg 45

Product Dimensions (W x D x H)

12.67 x 8.42 x 0.78 in

32.19 x 21.39 x 1.99 cm

Packaging Dimensions (W x D x H) 46

12"?-15"? boxes (305mm height): 1200mm x 1000mm x 1080mm

- 45. Weight will vary by configuration. Does not include power adapter.
- 46. Product packaging size varies based on options chosen. Please contact your HP representative for your packaging size details

PORTS/SLOTS

- 1 ThunderboltTM 4 with USB4TM Type-C[®] 40 Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4)⁴⁷
- 1 SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPortTM 1.4)
- 2 SuperSpeed USB Type-A 5Gbps signaling rate Port (1 Powered port)
- 1 AC power
- 1 HDMI 2.1 48
- 1 Headphone/microphone combo jack
- 1 Nano SIM slot for WWAN (optional)
- 1 RJ-45
- 1 Smart Card Reader (optional)
- 47. SuperSpeed USB 20Gbps is not available with ThunderboltTM 4
- 48. HDMI cable sold separately

SERVICE AND SUPPORT

1-year and 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a defa one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond t standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Too at: http://www.hp.com/go/cpc.⁴⁹

49. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicate Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

SYSTEM UNIT

Technical Specifications

Stand-Alone Power Requirements

(AC Power)

Nominal Operating Voltage 19V
Average Operating Power 3.81W
Integrated graphics Yes
Discrete Graphics Yes

Max Operating Power Discrete < 65W

UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C)

(No sustained direct exposure to sunlight)

(System performance may be reduced above 32°C (89.6°F))

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90% (non-condensing)

Non-operating 5% to 95%

(38.7° C (101.6° F) maximum wet bulb tempera-ture; non-condensing)

Shock

Operating 40 G, 2 ms, half-sine Non-operating 240 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grams
Non-operating 3.5 grams

Altitude (unpressurized)

Operating 10,000 ft (3,048 m) Non-operating 40,000 ft (12,192 m)

Planned Industry Standard

Certifications

Regulatory Model Number HSN-Q33C-4

CSA/UL 62368-1 Yes ENERGY STAR® Yes ⁵⁰

EPEAT® Gold in the United States 51

FCC/ICES/CISPR/VCCI Yes
CE MARKING Yes
GS Mark Yes

Related commodity should comply with ISO 9241 Standards.

China CCC/SRRC Yes Taiwan BSMI/NCC Yes Korea KCC/KC/KES Yes Ukraine NSoC/TEC Yes **EAEU Compliance** Yes Saudi Arabian Compliance Yes TCO Yes Low Blue Light Yes **WW RoHS** Yes

50. Configurations of the HP EliteBook 640 14 inch G10 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook 640 14 inch G10 Notebook PC ENERGY STAR on HP websites and on http://www.energystar.gov.

51. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit http://www.epeat.net for more information.

Technical Specifications

DISPLAYS

1. Actual brightness will be lower with touchscreen or HP Sure View.

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 14 inch FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR bent Touch on Panel NWBZ

 Outline Dimensions (W x H x D)
 316.170 x 186.400 (max)

 Active Area
 309.370 x 174.020 mm (tvp)

Weight 305 g (max)

Diagonal Size 14.0

Surface Treatment Anti-Glare On-cell

Touch Enabled Yes¹
Contrast Ratio 600:1 (typ)
Refresh Rate 60 Hz
Brightness 250 nits¹

Pixel Resolution - Format 1920 x 1080 (FHD)

BacklightLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%

Color Depth 6 (Hi FRC w/ condition to enable)

Viewing Angle UWVA 85/85/85

Low Blue Light No

Power Consumption (W, EBL@ 2.30 (max)/ 2.80 (max)

150nits max/ 200nits max)

14.0 in FHD (1920 x 1080) Anti-Glare UWVA Low Blue Light sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel

 Outline Dimensions (W x H x D)
 315.100 x 184.900 (max)

 Active Area
 309.370 x 174.020 mm (typ)

Weight 230g (max)
Diagonal Size 14.0
Surface Treatment Anti-Glare
Touch Enabled No

Contrast Ratio 1200:1 (typ)
Refresh Rate 60Hz
Brightness 400 nits¹

Pixel Resolution - Format 1920 x 1080 (FHD)

BacklightWLEDPixel ResolutionRGBColor Gamut Coverage\$RGB 100%

Color Depth 8

Viewing Angle UWVA 89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 1.23 (max)/1.5 (max) 150nits max/ 200nits max)

Technical Specifications

Panel LCD 14-in FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ bent

 Outline Dimensions (W x H x D)
 316.170 x 186.400 (max)

 Active Area
 309.370 x 174.020 mm (typ)

Weight 300 g (max)

Diagonal Size14.0Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio600:1 (typ)Refresh Rate60HzBrightness250 nits 1

Pixel Resolution - Format 1920 x 1080 (FHD)

BacklightLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%

Color Depth 6 (Hi FRC w/ condition to enable)

Viewing Angle UWVA 85/85/85

NEW - Low Blue Light No

NEW - Power Consumption (W, 2.205 (max)/ 2.716 (max)

EBL@ 150nits max/ 200nits max)

Panel LCD 14-in HD Outline Dimo (1366x768) Anti-Glare WLED Active Area SVA 45percent cg 250nits eDP 1.2 w/o PSR NWBZ bent

Outline Dimensions (W x H x D) 316.110 x 186.370 (max)

Active Area 309.400 x 173.950 mm (typ)

Weight 300 g (max)

Diagonal Size 14.0

Surface Treatment Anti-Glare

Touch Enabled No

 Contrast Ratio
 300:1 (typ)

 Refresh Rate
 60 Hz

 Brightness
 250 nits ¹

 Pixel Resolution - Format
 1366 x 768 (HD)

BacklightLEDPixel ResolutionRGBColor Gamut CoverageNTSC 45%

Color Depth 6

Viewing Angle SVA 45/45/15/35

Low Blue Light No

Power Consumption (W, EBL@ 2.52 (max) / 2.86 (max) 150nits max/ 200nits max)

Technical Specifications

14.0 in FHD (1920 x 1080) Anti-Glare UWVA Low Blue Light sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel

 Outline Dimensions (W x H x D)
 314.612 x 185.330 (max)

 Active Area
 309.312 x 173.990 (typ)

Weight230 g (max)Diagonal Size14.0Surface TreatmentAnti-Glare

Touch Enabled No

Contrast Ratio1500:1 (typ)Refresh Rate60 HzBrightness1000 nits 1

Pixel Resolution - Format 1920 x1080 (FHD)

BacklightWLEDPixel ResolutionRGBColor Gamut CoveragesRGB 100%

Color Depth 8

Viewing Angle UWVA 85/85/85

NEW - Low Blue Light Yes
NEW - Power Consumption (W, NA
EBL@ 150nits max/ 200nits max)

STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 256GB 2230 PCIe NVMe Value

Form Factor M.2 2230 Capacity 256GB **NAND Type** Value Interface PCIe NVMe Minimum Sequential Read 2000 MB/s ± 10% Minimum Sequential Write 900 MB/s ± 10% **Logical Blocks** 500.118.192 **Features** Pyrite; TRIM; L1.2

SSD 256GB 2280 PCIe NVMe Value Form Factor M.2 2280
Capacity 256GB
NAND Type Value
Interface PCIe NVMe

Minimum Sequential Read $2000 \text{ MB/s} \pm 10\%$ Minimum Sequential Write $900 \text{ MB/s} \pm 10\%$ Logical Blocks500,118,192

Features ATA Security; TRIM; L1.2

Technical Specifications

256GB PCIe 2280 NVMe **Self Encrypted OPAL2 Value Solid State Drive**

Form Factor M.2 2280 Capacity 256 GB **NAND Type** Opal2 Value Interface PCIe NVMe Gen4X4 Minimum Sequential Read 2000 MB/s ± 10%

Minimum Sequential Write 900 MB/s ± 10% Logical Blocks 500,118,192 **Features**

Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe **NVMe Value**

Form Factor M.2 2280 Capacity 512GB **NAND Type** Value Interface PCIe NVMe

Minimum Sequential Read 2200 MB/s ± 10% Minimum Sequential Write 1000 MB/s ± 10% **Logical Blocks** 1000215216

Features Pyrite 2.0, TRIM; L1.2

512GB PCIe-4x4 2280 **NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive**

Form Factor M.2 2280 Capacity 512 GB **NAND Type** Opal2 TLC Interface PCIe NVMe Gen4X4

Minimum Sequential Read 6400 MB/s ± 10% Minimum Sequential Write 3500 MB/s ± 10% **Logical Blocks** 1,000,215,216 **Features** Pyrite 2.0, TRIM; L1.2

512GB PCIe-4x4 2280 **NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive**

Form Factor M.2 2280 Capacity 512 GB **NAND Type** TLC Interface

PCIe NVMe Gen4X4 Minimum Sequential Read 6400 MB/s ± 10% **Minimum Sequential Write** 3500 MB/s ± 10% **Logical Blocks** 1,000,215,216 **Features** Pyrite 2.0, TRIM; L1.2

1TB PCIe-4x4 2280 NVME **Self Encrypted OPAL2 Three Layer Cell Solid State Drive**

Form Factor M.2 2280 Capacity 1 TB **NAND Type** Opal2 TLC Interface PCIe NVMe Gen4X4

Minimum Sequential Read 6400 MB/s ± 10% Minimum Sequential Write 5000 MB/s ± 10% **Logical Blocks** 2,000,409,264 **Features** Pyrite 2.0, TRIM; L1.2

Technical Specifications

SSD 1 TB 2280 PCIe NVMe Value¹ Form Factor M.2 2280
Capacity 1TB
NAND Type TLC

InterfacePCIe NVMe Gen4X4Minimum Sequential Read3200 MB/s ± 10%Minimum Sequential Write2700 MB/s ± 10%Logical Blocks2,000,409,264FeaturesPyrite 2.0; TRIM; L1.2

1. Available only to HK (Hong Kong), TW (Taiwan) and CN (China).

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell

 Form Factor
 M.2 2280

 Capacity
 2 TB

 NAND Type
 TLC

InterfacePCIe NVMe Gen4X4Minimum Sequential Read6400 MB/s ± 10%Minimum Sequential Write5000 MB/s ± 10%Logical Blocks4,000,797,360FeaturesPyrite 2.0, TRIM; L1.2

NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 M.2 160MHz CNVi World-wide WLAN vPro Wireless Card¹

Wireless LAN Standards

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11d
IEEE 802.11t
IEEE 802.11h
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r

IEEE 802.11v
Interoperability Wi-Fi certified

Frequency Band

• 802.11b/g/n/ax 2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11n: max 300Mbps

802.11n: max 300Mbps
802.11ac : 1733Mbps
802.11ax : max 2.4Gbps

Technical Specifications

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security ² IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power ³ 802.11b: +17dBm minimum

802.11g: +16dBm minimum 802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity 4 802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum

802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax, MCS11(HE40): -57dBm maximum 802.11ax, MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE80): -53.5dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8g

2. Type 1216: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Technical Specifications

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Amber - Radio OFF; LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz

Number of AvailableLegacy: 0~79 (1 MHz/CH)ChannelsBLE: 0~39 (2 MHz/CH)

Data Rates andLegacy: 3 Mbps data rate; throughput up to 2.17 Mbps **Throughput**BLE: 1 Mbps data rate: throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW Selective Suspend: 17 mW

Bluetooth Software

Supported Link Topology Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 -Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

BT5.3

Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Section 12.3 of BT 5.3 specification

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite

Technical Specifications

Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designe support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® AX211 Wi-Fi 6E +
Bluetooth® 5.3 M.2
160MHz CNVi World-wide
WLAN non-vPro Wireless
Card ¹

Wirele	ess LAN	I Standar	ds	Ш
				- 11

EEE 802.11a IEEE 802.11b IEEE 802.11q IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability

Wi-Fi certified

Frequency Band 802.11b/g/n/ax

2.402 - 2.482 GHz

802.11a/n/ac/ax

4.9 - 4.95 GHz (Japan)

5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz 5.955 - 6.415 GHz 6.435 - 6.515 GHz 6.535 - 6.875 GHz 6.895 - 7.115 GHz

Data Rates

- 802.11b: 1, 2, 5.5, 11 Mbps
- 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
- 802.11n: max 300Mbps 802.11ac: 1733Mbps 802.11ax: max 2.4Gbps

Modulation

Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security² IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification WPA3 certification IEEE 802.11i WAPI

Network Architecture

Ad-hoc (Peer to Peer)

Models Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points Output Power³ 802.11b: +17dBm minimum

802.11a: +16dBm minimum

Technical Specifications

802.11a: +17dBm minimum

802.11n HT20(2.4GHz): +14dBm minimum 802.11n HT40(2.4GHz): +13dBm minimum 802.11n HT20(5GHz): +14dBm minimum 802.11n HT40(5GHz): +13dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum 802.11ac VHT160(5GHz): +10dBm minimum 802.11ax HE40(2.4GHz): +12dBm minimum 802.11ax HE80(5GHz): +10dBm minimum 802.11ax HE160(5GHz): +10dBm minimum

Power Consumption Transmit mode 2.0 W

Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b. 1Mbps: -93.5dBm maximum

> 802.11b, 11Mbps: -84dBm maximum 802.11a/q, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

802.11ac. MCS0(VHT80): -84dBm maximum 802.11ac, MCS9(VHT80): -59dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum 802.11ax. MCS11(HE40): -57dBm maximum 802.11ax. MCS11(HE80): -54dBm maximum 802.11ax, MCS11(HE160): -53.5dBm maximum

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Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

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2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8q

2. Type 1216: 1.3q

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

> Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing) Non-operating

5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF; LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Card

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band 2402 to 2480 MHz **Number of Available** Legacy: 0~79 (1 MHz/CH) Channels BLE: 0~39 (2 MHz/CH)

Technical Specifications

Signaling Data Rate Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate: throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW Selective Suspend: 17 mW

Bluetooth Software Supported Link Topology Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Software Supported BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

BT5.3

Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Section 12.3 of BT 5.3 specification

- 1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limite Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designe support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Technical Specifications

Intel® XMMTM 7560 R+ LTE-Advanced Pro ¹ Technology/Operating bands FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3),

1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only),

2300 (Band 30), 1700/2100 (Band 66), 600 (band 71).

TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48),

5200 (Band 46 RX only) MHz;

HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),

850 (Band 5), 900 (Band 8) MHz

Wireless protocol standards 3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW

throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to

150Mbps

WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)

GPS bands 1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou

1561.098 MHz

Maximum data rates LTE: 978 Mbps (Download), 150 Mbps (Upload)

DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21 Mbps (Download), 5.76 Mbps (Upload)

Maximum output power LTE: 23 dBm in all band except B41

LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm

Maximum power consumption LTE: 1,200 mA (peak); 900 mA (average)

HSPA+: 1,100 mA (peak); 800 mA (average)

Form Factor M.2, 3042-S3 Key B

Weight 6 g

Dimensions 42 x 30 x 2.3 mm

(Length x Width x Thickness)

GPS

embedded eSIM Support

1. Mobile Broadband is an optional feature, Connection requires wireless data service contract, network support, and is not available all areas. Contact service providers determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE is not available on all products, in all regions.

NFC Mirage module (NXP NPC300 I2C 10mmx17mm)

Dimensions (L x W x H) Module 25 mm by 10 mm by 2.0 mm

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

Technical Specifications

Card Emulation (PICC-VICC) Mode ISO/IEC 14443 A ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer **Raw RF Data Rates** 106, 212, 424, 848 kbps

Operating temperature 0°C to 70°C

Storage temperature -20°C to 125°C

Humidity 10-90% operating

5-95% non-operating

Supply Operating voltage 4.35 to 5.25 Volts **I/O Voltage** 1.8V or 3.3V

Power Consumption (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V)

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

external to module.

Intel® I219-LM 1 Gigabit Network Connection LOM (vPro)

Connector RJ-45

System Interface PCI(Intel proprietary) + SMBus

Data rates supported 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE Compliance IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE (Energy Efficient Ethernet)

Performance TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload Receiving Side Scaling(Hash Mode Only)

Jumbo Frame 9K

Power consumption Cable Disconnetion: 25mW

100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW

Technical Specifications

Power ACPI compliant - multiple power modes

Management Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Management Interface

Auto MDI/MDIX Crossover cable detection

IT Manageability Wake-on-LAN from modern standby or sleep state (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Security & Manageability Intel® vProTM support with appropriate Intel® chipset components

Intel® I219v 1 Gigabit **Network Connection LOM** (non-vPro)

Connector **RJ-45**

System Interface PCI (Intel proprietary) + SMBus

Data rates supported 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

> 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE Compliance IEEE 802.1p OoS (Quality of Service) Support

IEEE 802.1a VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE (Energy Efficient Ethernet)

Performance TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload Receiving Side Scaling(Hash Mode Only)

Jumbo Frame 9K

Power consumption Cable Disconnetion: 25mW

> 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL Enable(\$3/\$4/\$5): 50mW WoL Disable(S3/S4/S5): 25mW

Power ACPI compliant - multiple power modes

Management Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Management Interface

Auto MDI/MDIX Crossover cable detection

IT Manageability Wake-on-LAN from modern standby or sleep state (Magic Packet and

Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Security & Manageability Intel® vProTM support with appropriate Intel® chipset components

POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life.

Technical Specifications

time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AC Adapter 65 Watt nPFC Standard USB Type C®

Straight 1.8m

Dimensions (H x W x D) 3.543 x 2.008 x 1.122 in (9.0 x 5.1 x 2.85 cm)

Weight 0.53 lb (240 g) max

(Not including power cord. Power cord varies by country.)

100~240VAC Input

> **Input Efficiency** Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:88% 15V:88% 20V:89%

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.6 A at 90 Vac

Output Output power 5V/15W

> 9V/27W 12V/60W 15V/60W 20V/65W

DC output 5V/9V/12V/15V/20V

Hold-up time 100% load 5ms at 115 Vac input

Output current limit <8.0A

USB TYPE C® Connector

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16.400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety

CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368

1:2014+A11, UL 62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC (Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia RCM, BIS, BSMI, UAE, UKCA DoC

Technical Specifications

AC Adapter 65 Watt Smart Dimensions (H x W x D) nPFC EM Barrel 4.5mm

4.016 x 2.165 x 1.181 in (10.2 x 5.5 x 3 cm)

Weight 0.58 lb (265 g) max

(Not including power cord. Power cord varies by country.)

Input 100 ~ 240VAC

> **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output **Output power** 65W

> **DC** output 19.5V

Hold-up time 100% load 5ms at 115 Vac input/80% load

10ms at 115 Vac input

Output current limit <11.0A

Connector 4.5mm Barrel Type

Environmental Design 32°F to 95°F (0°to 35°C) Operating

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368 Certifications

1:2014+A11, UL62368-1

Agency approvals - C-UL-US, TUV/GS, EN55032 Class B, FCC Class B,

CISPR32 Class B, CCC and CECP, BIS, UKCA DoC

AC Adapter 65 Watt Smart Dimensions (H x W x D) nPFC Standard Barrel 4.5mm Right Angle 1.8m

3.543 x 2.008 x 1.122 in (9.0 x 5.1 x 2.85 cm)

Weight 0.55 lb (250 g) max

(Not including power cord. Power cord varies by country.)

Input 100 ~ 240VAC

> 88.0 % at 115 Vac and 89.0 % at 230Vac **Input Efficiency**

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

> **DC** output 19.5V

Hold-up time 100% load 5ms at 115 Vac input/80% load

10ms at 115 Vac input

<11.0A **Output current limit**

Connector 4.5mm Barrel Type

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage)

-4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

Technical Specifications

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368

1:2014+A11, UL62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC

HP 65W Slim USB-C Dimensi Straight AC Power Adapter Weight

Dimensions (H x W x D)

97.00 x 53.05 x 21.00 mm

Weight Input 230g +/- 10g 100~240VAC

Input Efficiency

81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range

47 ~ 63 Hz

Input AC current

Max. 1.6 A at 90 VAC

Output Output power 65 W

DC output 5V/9V/12V/15V/20V **Hold-up time** 5ms at 115 Vac input

Output current limit <8.0A

Connector USB TYPE C®

Environmental Design Operating

32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage)

-4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950-1 and IEC62368-1: 2018, EN62368

1:2014+A11. UL62368-1

Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC and CECP, CU(EAC), EAEU, KCC(Safety+EMC) and K-MEPS, NOM-001 and 029 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-

mark, Australia GEMS and RCM, BIS, BSMI, UAE, UKCA DoC

Technical Specifications

RH 51Whr Long Life

Polymer Fast Charge 3 cell

Batterv¹

Weight 0.2025 kg (0.446 lb)

Cells/Type 3cell Lithium-Ion Polymer cell / 566075

Energy Voltage 11.58V

Amp-hour capacity 4.431Ah Watt-hour capacity 51.3Wh

Temperature Operating (Charging) 32? to 113? F (0? to 45? C)

Operating (Discharging) 14? to 122? F (-10? to 60? C)

Optional Travel Battery
No

Available

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage,

environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

AUDIO

HD Stereo Codec Realtek ALC3247

Audio 1/0 Ports Headset connector supports a CTIA style headset and is re-taskable as a

Microphone-in or Headphone-out port

Internal Speaker Amplifier

ALC 3247 has Embedded Class-D 2W Stereo Amplifier

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow

independent audio

Sampling streams to be sent to/from the front and rear jacks or integrated speaker.

Wavetable Syntheses Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to

24-bit; 44.1 kHz:

Internal SPK/Headphone/External MIC

24bit,48000Hz: Digital MIC

Analog Audio Support 3.5mm Headset: CTIA only and Headphone-out

of Channels on Line-Out We do not support Line-Out

Internal Speaker Yes

FINGERPRINT READER

Sensor vendorELAN 80STSensor typeCapacitiveDPI resolution508 DPIScan area80x80 pixels

False Rejection Rate <3%
False Acceptance Rate <0.001%
Mobile Voltage Operation 2.7~3.6V
Operating Temperature -20°C - +80°C
Current Consumption Image 35mA peak
Low Latency Wait For Finger 900uA

Capture RateCapture Rate: 50 frame/secESD ResistanceIEC 61000-4-2 4B (+15KV)Detection Matrix508 dpi / 4x4mm sensor area

ENVIRONMENTAL DATA

Eco-Label Certifications &

declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

IT ECO declaration

Technical Specifications

rechnical Specifications						
	 US ENERGY STAR® US Federal Energy Management Program (FEMP) EPEAT^a Gold registered in the United States. See http://www.epeat.net for registration status in your country. TCO Certified China Energy Conservation Program (CECP) China State Environmental Protection Administration (SEPA) Taiwan Green Mark Korea Eco-label Japan PC Green label* 					
Sustainable Impact Specifications	 Ocean-bound plastic in speaker 5% post-consumer recycled plastic 50% recycled metal Low halogen Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable Bulk packaging available 					
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook"?.					
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC,	50Hz	100VAC, 50Hz		
Normal Operation (Sort	5.06 W	5.04		5.29 W		
idle) Normal Operation (Long idle)	1.1 W	1.19	W	1.1 W		
Sleep	1.1 W	1.19	W	1.1 W		
Off	0.29 W	0.32	W	0.29 W		
	family. HP computers marked Environmental Protection Ag does not offer ENERGY STAR typically configured PC featu Windows® operating system	d with the ENER(ency (EPA) ENER compliant conf ring a hard disk	SY STAR® Log RGY STAR® sp igurations, th drive, a high e	oliant product if offered within the model o are compliant with the applicable U.S. ecifications for computers. If a model fam nen energy efficiency data listed is for a efficiency power supply, and a Microsoft		
Heat Dissipation*	115VAC, 60Hz	230VAC,	50Hz	100VAC, 50Hz		
Normal Operation (Short idle)	17.3 BTU/hr	17.2 BT	II/hr	18.1 BTU/hr		
Normal Operation (Long	17.5 516,111	17.2 01	O/III	13.1 513/11		
idle)	3.8 BTU/hr	4.1 BT		3.8 BTU/hr		
Sleep	3.8 BTU/hr	4.1 BT		3.8 BTU/hr		
Off	1.0 BTU/hr	1.1 BT	J/hr	1.0 BTU/hr		
	attained for one hour.		n the measur	ed watts, assuming the service level is		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)		Sound Pressure (L _{pAm} , decibels)			
Typically Configured - Idle	2.6		14.6			
Fixed Disk - Random writes	2.8		16.3			
Optical Drive - Sequential	3.6		30.1			
reads						

Technical Specifications

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the						
	Spare parts are available throughout the warranty period and or for up to "5"? years after the end of production.					
Additional Information	directive This HP p Equipmer This produ Drinking V This produ see www. Plastics p and ISO10	arts weighing over 25 grams used in the product are r	cal and Electronic ate of California; Safe Indard at the Gold level, marked per ISO11469			
Packaging Materials	External:	PAPER/Corrugated	230 g			
		PAPER/Corrugated	51 g			
		PAPER/Molded Pulp	61 g			
	Internal:	PLASTIC/Polyethylene low density - LDPE	9 g			
	The plastic packaging material contains at least 0.0% recycled content. The corrugated paper packaging materials contains at least 57.0% recycled content.					
Material Usage	extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances-including PVC, BFRs, and certain phthalates-in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.					
	the HP General S http://www.hp.c gen_specification	o Colorants ominated Flame Retardants - may not be used as flame r od Hydrocarbons d Paraffins othexyl) phthalate (DEHP) cyl phthalate (BBP) thalate (DBP) phthalate (DIBP)				

Technical Specifications Mercuric Oxide Batteries Nickel - finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) - except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. **Radioactive Substances** Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) **Packaging Usage** HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. **End-of-life Management** HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle and Recycling your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment. HP, Inc. Corporate For more information about HP's commitment to the environment: **Environmental** Information Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf Percentage of ocean-bound plastic contained in each component varies by product footnotes Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard. External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers. Fiber cushions made from 100% recycled wood fiber and organic materials. Plastic cushions are made from >90% recycled plastic. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.



Technical Specifications

COUNTRY OF ORIGIN

China

Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

Docking station model #1 HP Thunderbolt 120W G4 Dock

Total number of supported displays (incl.

the notebook display)

Max. resolutions supported

Ouad 4K @60Hz

Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res

mode

4

Dock Connectors 2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode

Technical limitations Maximum resolution and display support is dependent on the maximum capability

of the notebook. Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt hos

or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-

function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD

@ 30Hz.

Docking station model #2

Total number of supported displays (incl.

the notebook display)
Max. resolutions supported

HP Thunderbolt 280W G4 Dock

1414 0 6 01

Quad 4K @60Hz

Dual 8K single cable@30 for TB hosts or USB-C hosts DP 1.4 with DSC in high res

mode

4

Dock Connectors 2xDP, 1xHDMI, 1xTB, 1xUSB-C Alt Mode

Technical limitations Maximum resolution and display support is dependent on the maximum capability

of the notebook. Thunderbolt Hosts:

Maximum of (4) displays with maximum resolution of 5K@ 30Hz running

Thunderbolt host.

Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt hos

or running a non-Thunderbolt host in high resolution mode @30Hz

Non-Thunderbolt hosts:

The highest resolution for dual displays running a non-Thunderbolt host in multi-

function mode is

(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port

Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD

@ 30Hz.

Docking station model #3

HP USB-C Dock G5

Total number of supported displays (incl.

the notebook display) Max. resolutions supported 3

Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode)

Dock Connectors 1xHDMI, 2xDP

Technical limitationsMaximum resolution and display support is dependent on the maximum capability

of the notebook.

Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution

mode.

Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K

UHD@ 30 Hz on HDMI in Multi-function mode

Options and Accessories (Sold separately and availability may vary by country)

The highest resolution for a non-Thunderbolt host in Multi-function mode is a

single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.

Docking station model #4

HP USB-C/A Universal Dock G2

Total number of supported displays (incl.

the notebook display)
Max. resolutions supported

3

Dual 4K @ 60Hz Single 5K @ 60Hz 1xHDMI. 2xDP

Dock Connectors
Technical limitations

Maximum resolution and display support is dependent on the maximum capability

of the notebook.

The best resolution for dual or triple displays is 4K UHD@ 60Hz.

For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host

Docking station model #5

HP USB-C G5 Essential Dock

Total number of supported displays (incl.

the notebook display) Max. resolutions supported 3

For hosts that support DisplayPort 1.4 with Display Stream Compression:

3x FHD @ 60 Hz 3x QHD @ 60 Hz 3x 4K @ 60 Hz

For hosts that support DisplayPort 1.3/1.4:

3x FHD @ 60 Hz 3x QHD @ 60 Hz 2x 4K @ 60 Hz 1 x HDMI, 2 x DP

Technical limitations

Dock Connectors

Video resolution depends on the capability of the host machine. This dock provide

up to 65W of power delivery to the host machine.

Туре	Description	Part Number
Audio	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
	HP 365 BT Speaker	567D3AA#ACJ
Video	HP 325 FHD USB-A Webcam	53X27AA
	HP 965 4K USB-A STR Webcam	695J5AA
Cases	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Executive 14.1 Laptop Sleeve	6B8Y3AA
	HP Renew Executive 16 Laptop Backpack	6B8Y1AA
	HP Renew Executive 16 Laptop Bag	6B8Y2AA

Options and Accessories (Sold separately and availability may vary by country)

Docking	HP USB-C 120W G5 Dock	5TW10AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP Thunderbolt 120W G4 Dock	4J0A2AA
	HP Thunderbolt 280W G4 Dock	4J0G4AA
Hub	HP 4K USB-C Multiport Hub	6G842AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP USB-C to RJ45 Adapter G2	4Z527AA
Adaptei	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
	in oblicio valimaapiei	NSIN OILL
Keyboard/Combo	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 355 Compact Multi-Device BT Keyboard	692S9AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 155 Wired Mouse and Keyboard Combo	5B8C0AA#ACJ
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 155 USB-A Wired Mouse	5B8B7AA#ACJ
	HP 235 Wireless 2.4GHz Slim Wireless Mouse	4E407AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP 435 Bluetooth 5.0 + Wireless 2.4GHz Multi-Device Wireless Mouse	3B4Q5AA
	HP 715 Rechargeable Multi-Device Bluetooth 5.0 + Wireless 2.4GHz Bluetooth Mouse	6E6F0AA
	HP 925 Ergonomic Vertical Bluetooth 5.0 + Wireless 2.4GHz Wireless Mouse	6H1A5AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA
	HP USB Premium Wireless Mouse	1JR31AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1DOK2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA

Options and Accessories (Sold separately and availability may vary by country)

Power	HP 45W USB-C LC AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W GaN USB-C Laptop Charger	600Q7AA
	HP 65W USB-C Laptop Charger	671R3AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 90W 4.5 mm Smart AC Power Adapter	H6Y90AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA
	HP Combination Nano Cable Lock	63B28AA
	HP Essential Combination Nano Cable Lock	63B31AA

Change Log

Date of change:	Version History:		Description of change:
March 30, 2023	V1 to V2	Added	Battery life and updated At a Glance section
April 24, 2023	V2 to V3	Updated	WWAN CAT in At a Glance section
May 18, 2023	V3 to V4	Updated	Storage and Drives section
June 5, 2023	V4 to V5	Updated	Storage and Drives section
	V5 to V6		-

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